

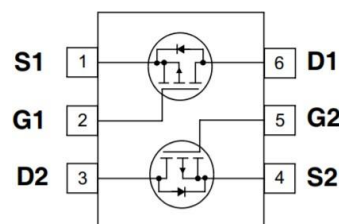
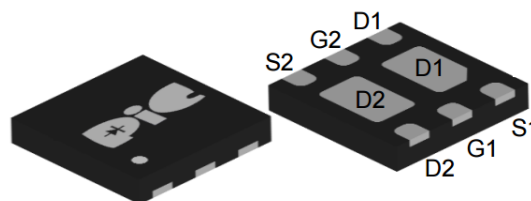
### ➤ General Description

This PAP28TS01S Dual P-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent  $R_{ds(On)}$  performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

### ➤ Feature

- Super Low Gate Charge
- Green Device Available
- Excellent  $CdV/dt$  effect decline
- Advanced high cell density Trench technology
- DFN2X2A-EP2 package design

### ➤ DFN2X2A-EP2



### ➤ Absolute Maximum Ratings

| Parameter                                                         | Symbol               | Rating     | Units        |
|-------------------------------------------------------------------|----------------------|------------|--------------|
| Drain-Source Voltage                                              | $V_{DS}$             | -20        | V            |
| Gate-Source Voltage                                               | $V_{GS}$             | $\pm 12$   | V            |
| Continuous Drain Current <sup>1</sup>                             | $I_D@T_A=25^\circ C$ | -3.0       | A            |
| Continuous Drain Current <sup>1</sup>                             | $I_D@T_A=70^\circ C$ | -2.3       | A            |
| Pulsed Drain Current <sup>2</sup>                                 | $I_{DM}$             | -12        | A            |
| Total Power Dissipation <sup>3</sup>                              | $P_D@T_A=25^\circ C$ | 1.8        | W            |
| Storage Temperature Range                                         | $T_{STG}$            | -55 to 150 | $^\circ C$   |
| Operating Junction Temperature Range                              | $T_J$                | -55 to 150 | $^\circ C$   |
| Thermal Resistance Junction-ambient <sup>1</sup>                  | $R_{\theta JA}$      | 150        | $^\circ C/W$ |
| Thermal Resistance Junction-ambient <sup>1</sup> ( $t \leq 10s$ ) | $R_{\theta JA}$      | 69         | $^\circ C/W$ |

### ➤ Electrical Characteristics ( $T_J=25^\circ C$ Unless otherwise noted)

| Parameter                                      | Symbol       | Conditions                                                    | Min.  | Typ. | Max.      | Unit      |
|------------------------------------------------|--------------|---------------------------------------------------------------|-------|------|-----------|-----------|
| Drain-Source Breakdown Voltage                 | $BV_{DSS}$   | $V_{GS}=0V$ , $I_D=-250\mu A$                                 | -20   | ---  | ---       | V         |
| Static Drain-Source On-Resistance <sup>2</sup> | $R_{DS(ON)}$ | $V_{GS}=-4.5V$ , $I_D=-3A$                                    | ---   | 86   | 110       | $m\Omega$ |
|                                                |              | $V_{GS}=-2.5V$ , $I_D=-2A$                                    | ---   | 120  | 150       |           |
|                                                |              | $V_{GS}=-1.8V$ , $I_D=-0.9A$                                  | ---   | 170  | 240       |           |
| Gate Threshold Voltage                         | $V_{GS(th)}$ | $V_{GS}=V_{DS}$ , $I_D=-250\mu A$                             | -0.45 | -0.6 | -1.0      | V         |
| Drain-Source Leakage Current                   | $I_{DSS}$    | $V_{DS}=-16V$ , $V_{GS}=0V$ , $T_J=25^\circ C$                | ---   | ---  | -1        | $\mu A$   |
|                                                |              | $V_{DS}=-16V$ , $V_{GS}=0V$ , $T_J=55^\circ C$                | ---   | ---  | -5        |           |
| Gate-Source Leakage Current                    | $I_{GSS}$    | $V_{GS}=\pm 12V$ , $V_{DS}=0V$                                | ---   | ---  | $\pm 100$ | nA        |
| Forward Transconductance                       | $g_{fs}$     | $V_{DS}=-5V$ , $I_D=-3A$                                      | ---   | 12.2 | ---       | S         |
| Total Gate Charge (-4.5V)                      | $Q_g$        | $V_{DS}=-15V$ , $V_{GS}=-4.5V$ , $I_D=-3A$                    | ---   | 10.1 | ---       | nC        |
| Gate-Source Charge                             | $Q_{gs}$     |                                                               | ---   | 1.21 | ---       |           |
| Gate-Drain Charge                              | $Q_{gd}$     |                                                               | ---   | 2.46 | ---       |           |
| Turn-On Delay Time                             | $T_{d(on)}$  | $V_{DD}=-10V$ , $V_{GS}=-4.5V$ , $R_G=3.3\Omega$<br>$I_D=-3A$ | ---   | 5.6  | ---       | ns        |
| Rise Time                                      | $T_r$        |                                                               | ---   | 32.2 | ---       |           |
| Turn-Off Delay Time                            | $T_{d(off)}$ |                                                               | ---   | 45.6 | ---       |           |
| Fall Time                                      | $T_f$        |                                                               | ---   | 29.2 | ---       |           |
| Input Capacitance                              | $C_{iss}$    | $V_{DS}=-15V$ , $V_{GS}=0V$ , $f=1MHz$                        | ---   | 677  | ---       | pF        |
| Output Capacitance                             | $C_{oss}$    |                                                               | ---   | 82   | ---       |           |
| Reverse Transfer Capacitance                   | $C_{rss}$    |                                                               | ---   | 73   | ---       |           |

### ➤ Diode Characteristics

| Parameter                                | Symbol   | Conditions                                 | Min. | Typ. | Max. | Unit |
|------------------------------------------|----------|--------------------------------------------|------|------|------|------|
| Continuous Source Current <sup>1,4</sup> | $I_S$    | $V_G=V_D=0V$ , Force Current               | ---  | ---  | -3   | A    |
| Diode Forward Voltage <sup>2</sup>       | $V_{SD}$ | $V_{GS}=0V$ , $I_S=-1A$ , $T_J=25^\circ C$ | ---  | ---  | -1   | V    |

Note :

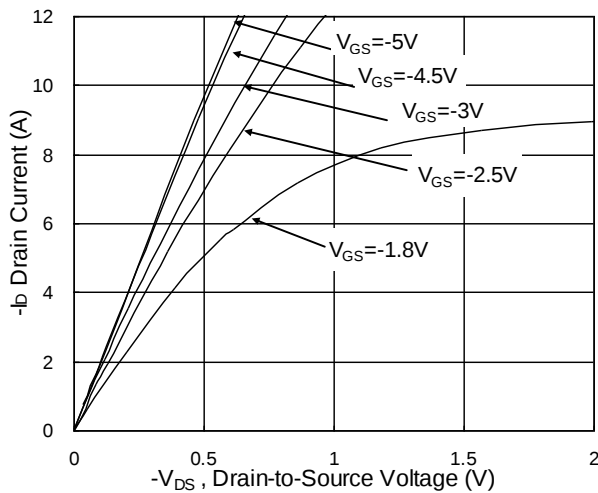
1.Pulse width limited by maximum junction temperature.

2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$

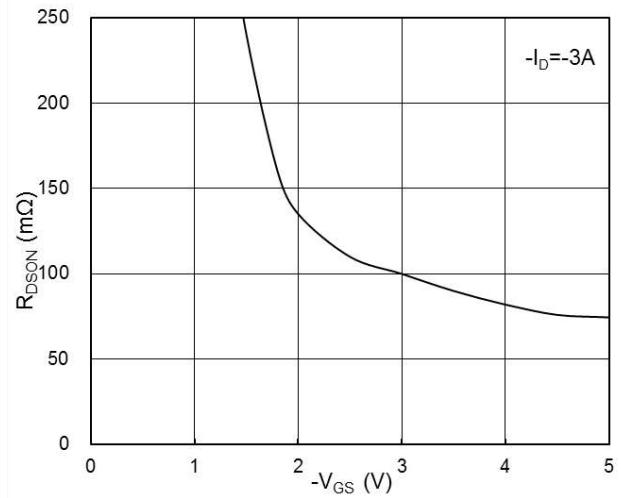
3.Ensure that the channel temperature does not exceed  $150^\circ C$ .

4.The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

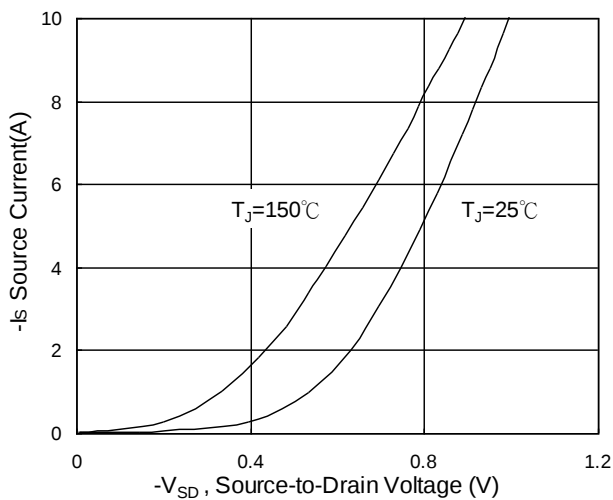
### ➤ Typical Characteristics



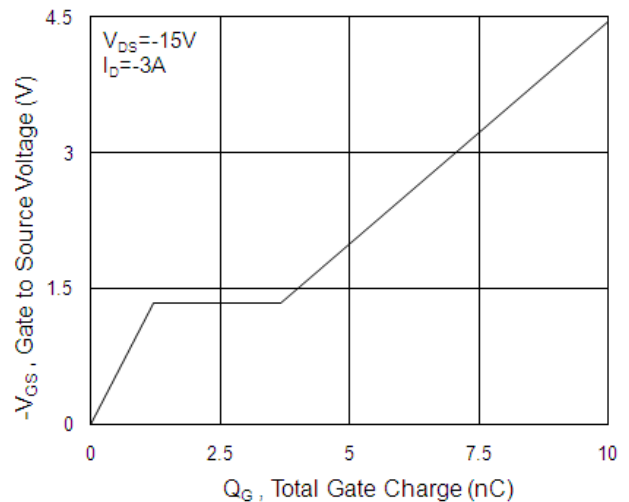
**Fig.1 Typical Output Characteristics**



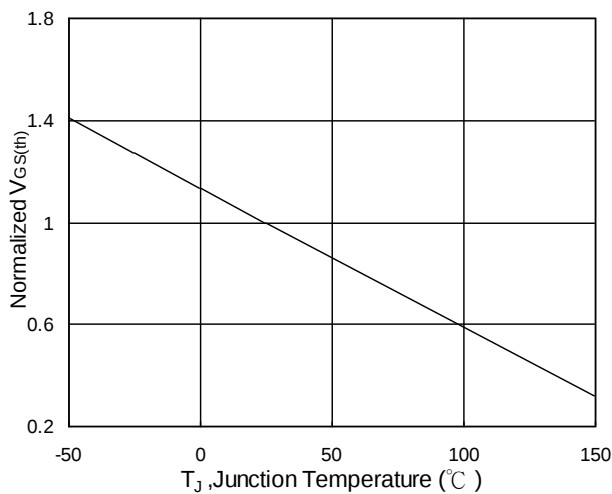
**Fig.2 On-Resistance vs. G-S Voltage**



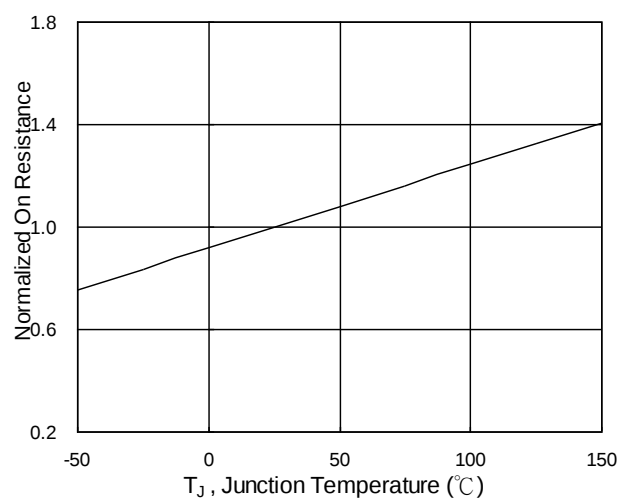
**Fig.3 Source Drain Forward Characteristics**



**Fig.4 Gate-Charge Characteristics**



**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



**Fig.6 Normalized  $R_{DS(ON)}$  vs.  $T_J$**

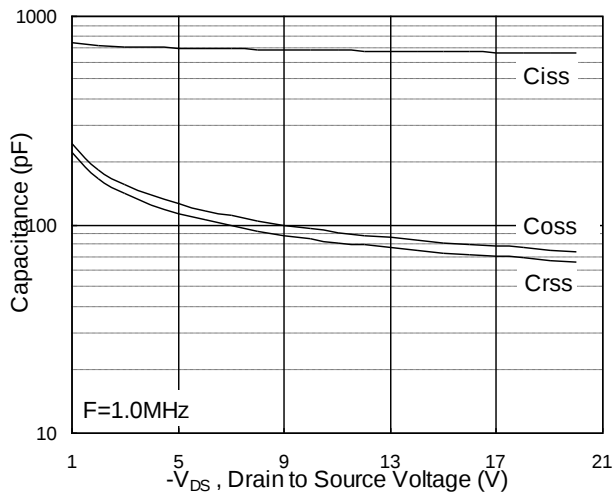


Fig.7 Capacitance

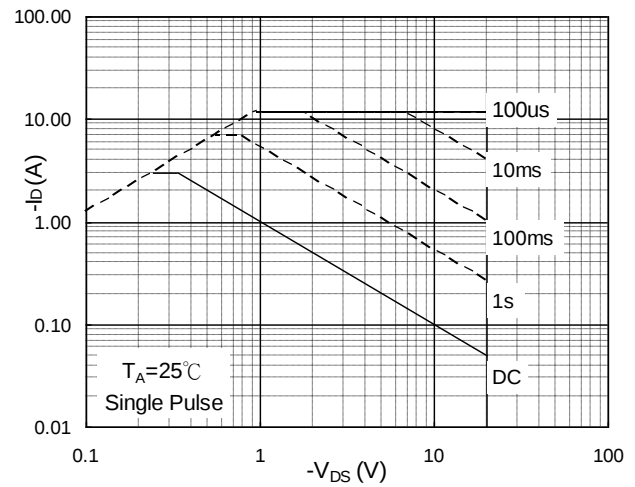


Fig.8 Safe Operating Area

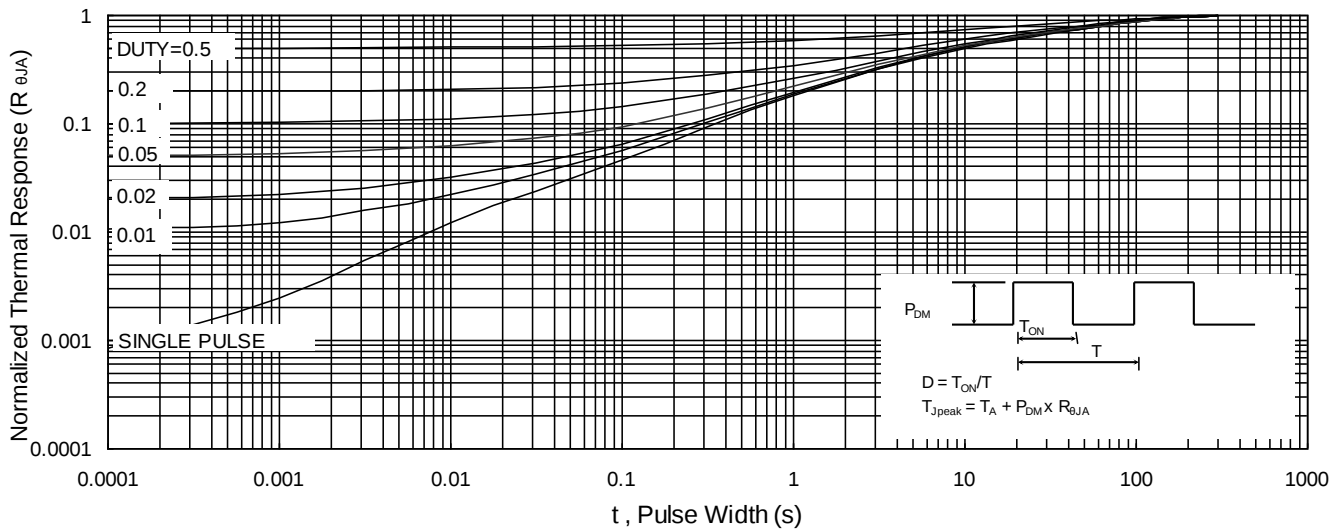


Fig.9 Normalized Maximum Transient Thermal Impedance

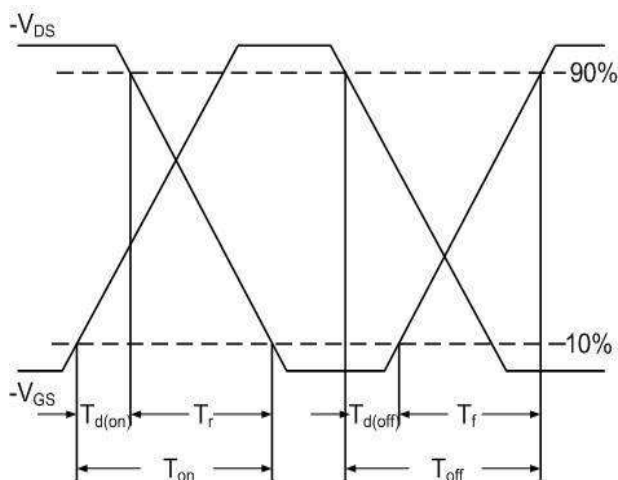


Fig.10 Switching Time Waveform

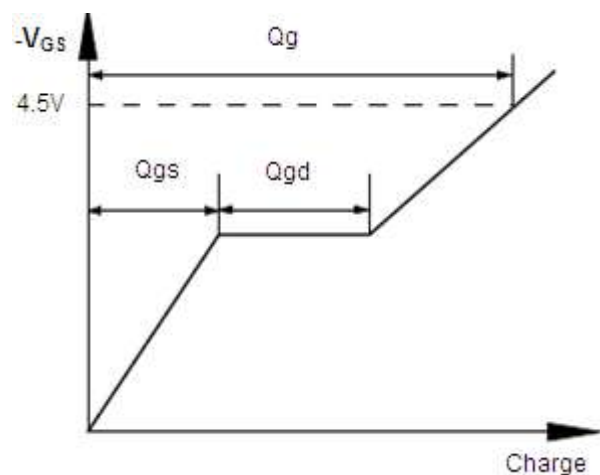
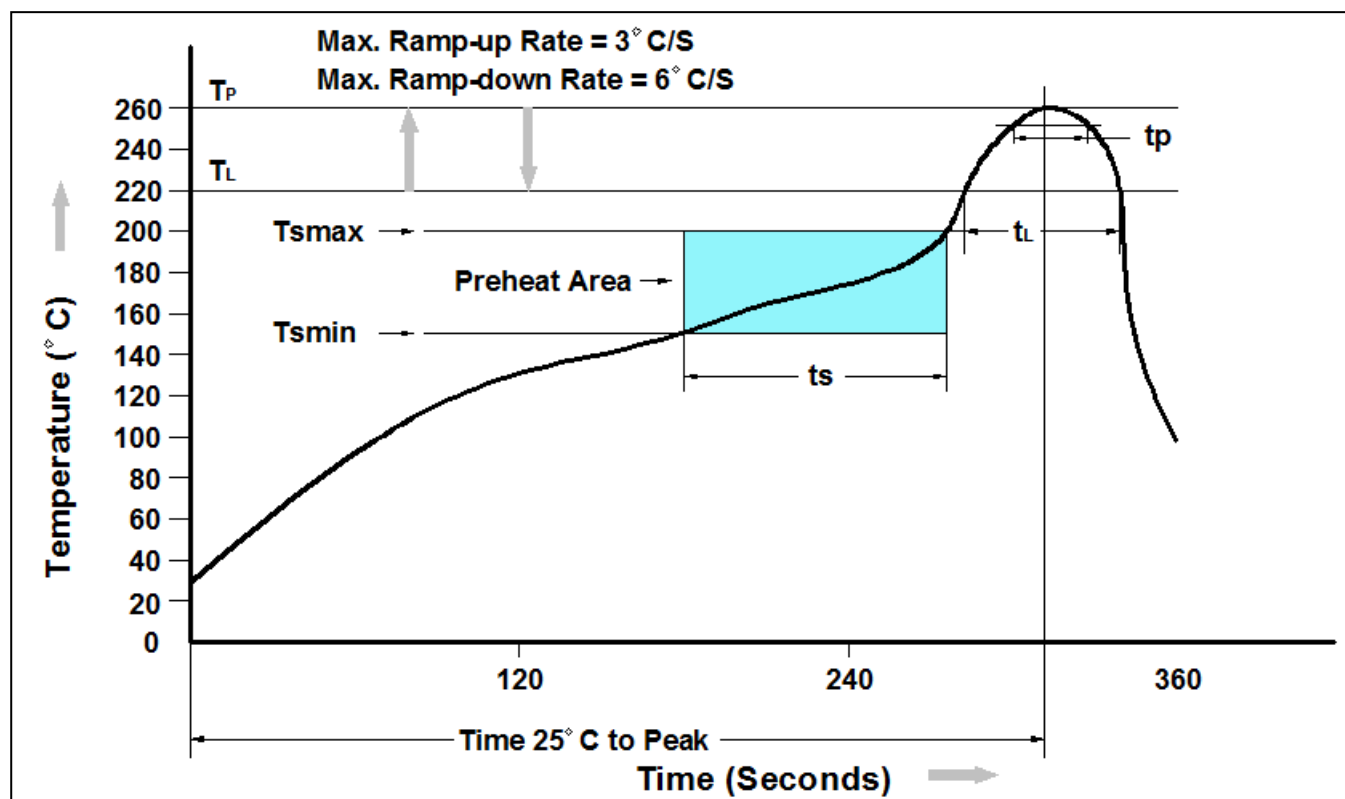


Fig.11 Gate Charge Waveform

### ➤ Recommend IR Reflow Soldering Thermal Profile

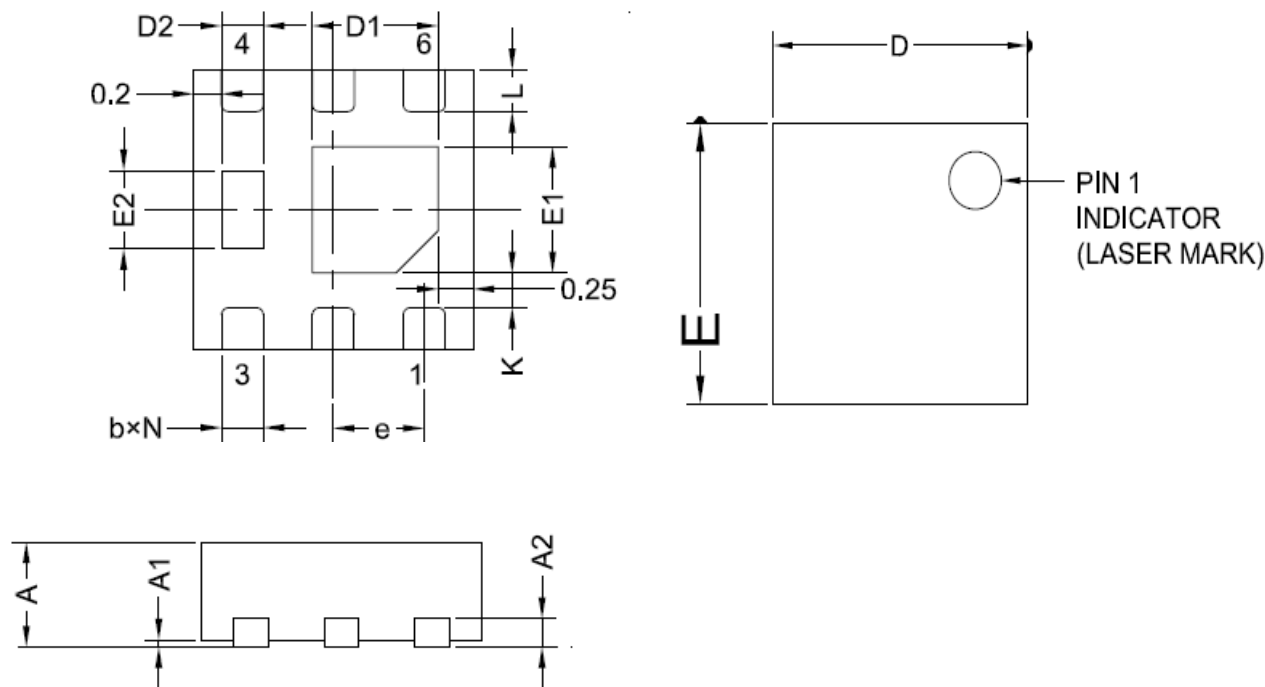


| Profile Feature                                      | Pb-Free Assembly Profile |
|------------------------------------------------------|--------------------------|
| Temperature Min. ( $T_{smin}$ )                      | 150°C                    |
| Temperature Max. ( $T_{smax}$ )                      | 200°C                    |
| Time ( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )     | 60-120 seconds           |
| Average Ramp-up Rate ( $t_L$ to $t_P$ )              | 3°C/second max.          |
| Liquidous Temperature ( $T_L$ )                      | 217°C                    |
| Time ( $t_L$ ) Maintained Above ( $T_L$ )            | 60 – 150 seconds         |
| Peak Temperature                                     | 260°C +0°C / -5°C        |
| Time ( $t_P$ ) within 5°C of actual Peak Temperature | 30 seconds               |
| Ramp-down Rate ( $T_P$ to $T_L$ )                    | 6°C/second max           |
| Time 25°C to Peak Temperature                        | 8 minutes max.           |

### ➤ Ordering Information

| Part Number | Description      | Quantity |
|-------------|------------------|----------|
| PAP28TS01S  | DFN2X2A-EP2 Reel | 3000 pcs |

### ➤ Package Information (DFN2X2A-EP2)



| SYMBOLS | MILLIMETERS |       | INCHES  |        |
|---------|-------------|-------|---------|--------|
|         | MIN         | MAX   | MIN     | MAX    |
| A       | 0.500       | 0.600 | 0.0197  | 0.0236 |
| A1      | 0.000       | 0.050 | 0       | 0.0020 |
| A2      | 0.152       |       | 0.0060  |        |
| b       | 0.250       | 0.350 | 0.0098  | 0.0138 |
| D       | 1.950       | 2.050 | 0.0767  | 0.0807 |
| D1      | 0.800       | 1.000 | 0.0315  | 0.0394 |
| D2      | 0.250       | 0.350 | 0.0098  | 0.0138 |
| E       | 1.950       | 2.050 | 0.0767  | 0.0807 |
| E1      | 0.800       | 1.000 | 0.0315  | 0.0394 |
| E2      | 0.460       | 0.660 | 0.0181  | 0.260  |
| e       | 0.650       |       | 0.0256  |        |
| L       | 0.250       | 0.350 | 0.0098  | 0.0138 |
| J       | 0.400       |       | 0.01575 |        |
| K       | 0.200       | --    | 0.00787 | --     |
| N       | 6           |       | 6       |        |

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